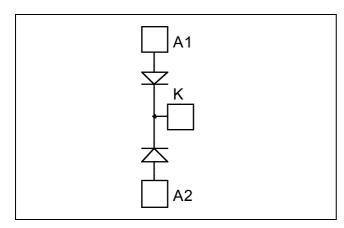


Dual Common Cathode diodes Power Module

$$egin{array}{l} V_{CES} = 1200V \\ I_{C} = 400A @ Tc = 60^{\circ}C \end{array}$$



Application

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration



- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter				Max ratings	Unit	
V_R	Maximum DC reverse Voltage				1200	V	
V_{RRM}	Maximum Peak Repetitive Revers	e Voltage			1200	V	
$I_{F(AV)}$	Maximum Average Forward	Duta 2001 - 500/		$T_C = 25^{\circ}C$	470		
	Current	Duty cycle =	50%	$T_C = 60$ °C	400	Α	
I _{F(RMS)}	RMS Forward Current	Duty cycle =	50%	$T_C = 45^{\circ}C$	500	Α	
I_{FSM}	Non-Repetitive Forward Surge Cu	rrent 8	.3ms	$T_C = 45^{\circ}C$	3000		

TAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{F}	Diode Forward Voltage	$I_F = 400A$			2.4	3.0	
		$I_F = 600A$			2.7		V
		$I_F = 400A$	$T_{j} = 125^{\circ}C$		1.8		
I_{RM}	Maximum Reverse Leakage Current	$V_R = 1200V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$			250	4	
			$T_{j} = 125^{\circ}C$			1000	μΑ
C_{T}	Junction Capacitance	$V_R = 1200V$			440		pF

Dynamic Characteristics

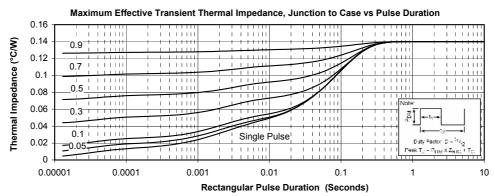
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
t_{rr}	Reverse Recovery Time	$I_F=1A, V_R=30V$ $di/dt = 400A/\mu s$	$T_j = 25$ °C		45		ns
t_{rr}	Reverse Recovery Time	$T_j = 25^{\circ}C$		385		ns	
c rr	reverse receivery Time		$T_j = 125$ °C		480		115
Q _{rr}	Reverse Recovery Charge	$I_F = 400A$ $V_R = 800V$ $di/dt = 800A/\mu s$	$T_j = 25^{\circ}C$		4.2		μС
Qrr	Reverse Recovery Charge		$T_j = 125^{\circ}C$		20.9		
T	Reverse Recovery Current	,	$T_j = 25^{\circ}C$		24		A
I_{RRM}	Reverse Recovery Current		$T_{j} = 125^{\circ}C$		76		Λ
t_{rr}	Reverse Recovery Time	$I_F = 400A$ $V_R = 800V$ $di/dt = 4000A/\mu s$			210		ns
Qrr	Reverse Recovery Charge		$T_j = 125$ °C		38		μС
I_{RRM}	Reverse Recovery Current				280		A

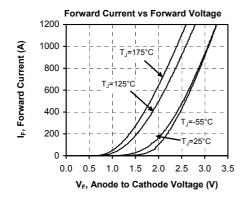
Thermal and package characteristics

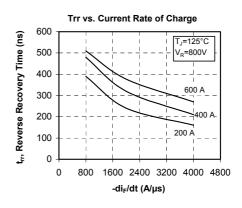
Symbol	Characteristic			Min	Тур	Max	Unit		
R_{thJC}	Junction to Case Thermal Resistance					0.14	°C/W		
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V		
T_{J}	Operating junction temperature range			-40		175			
T _{STG}	Storage Temperature Range			-40		125	°C		
$T_{\rm C}$	Operating Case Temperature					100			
Torque	Mounting torque	To heatsink	M6	3		5	N.m		
	Woulding torque	For terminals	M5	2		3.5	11.111		
Wt	Package Weight					300	g		

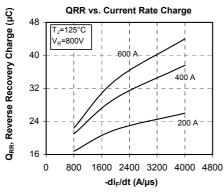


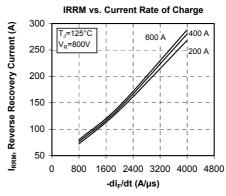
Typical Performance Curve

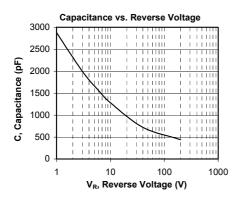


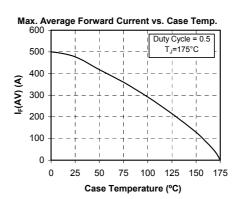






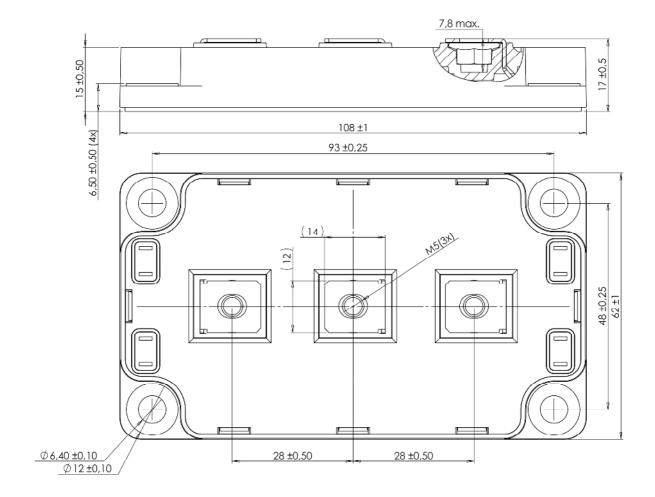








SP6 Package outline (dimensions in mm)





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